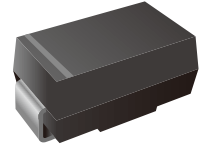


## Surface Mount Schottky Barrier Rectifier

### Features

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- Lead free in comply with EU RoHS 2011/65/EU directives



### Mechanical Data

- Case:SMA
- Terminals: leads solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Approx. Weight: 60mg

### Ordering Information

Part Number	Shipping	Reel
LT32A THRU LT320A-TR5	5000PCS Tape&Reel	13 inches
LT32A THRU LT320A-TR7K5	7500PCS Tape&Reel	13 inches

### Maximum Ratings and Electrical Characteristics

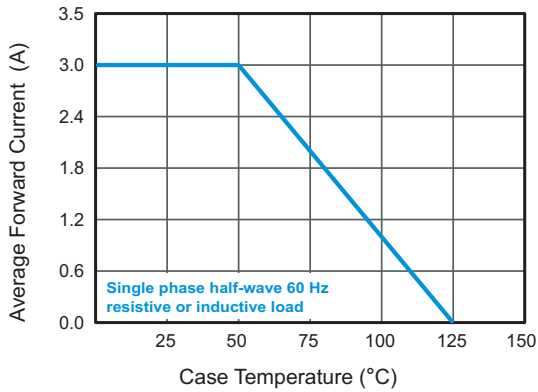
Ratings at 25°C ambient temperature unless otherwise specified.  
 Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	Symbol	LT32A	LT34A	LT36A	LT38A	LT310A	LT312A	LT315A	LT320A	Unit
Maximum repetitive peak reverse voltage	$V_{RRM}$	20	40	60	80	100	120	150	200	V
Maximum RMS voltage	$V_{RMS}$	14	28	42	56	70	84	105	140	V
Maximum DC blocking voltage	$V_{DC}$	20	40	60	80	100	120	150	200	V
Maximum average forward rectified current @ Fig.1	$I_{F(AV)}$	3								A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	80								A
Maximum instantaneous forward voltage at 3.0A	$V_F$	0.55	0.70	0.85	0.95					V
Maximum DC reverse current at rated DC reverse voltage $T_A=25^\circ\text{C}$ $T_A=100^\circ\text{C}$	$I_R$	0.5 5			0.3 3					mA
Typical junction capacitance (Note1)	$C_J$	135	107	83	68		50			pF
Typical thermal resistance (Note2)	$R_{\theta JA}$ $R_{\theta JC}$ $R_{\theta JL}$	100 20 25								$^\circ\text{C/W}$
Operating junction temperature range	$T_J$	-55 to +150								$^\circ\text{C}$
Storage temperature range	$T_{STG}$	-55 to +150								$^\circ\text{C}$

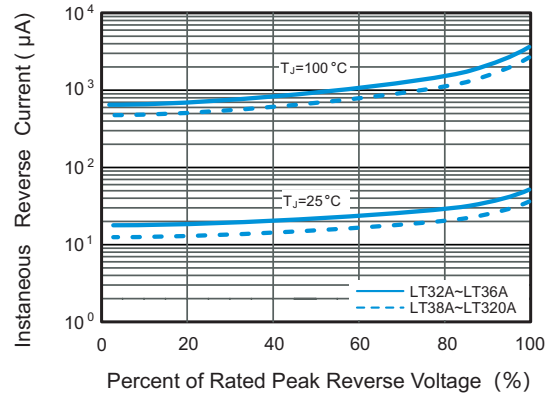
Note: (1) Measured at 1MHz and applied reverse voltage of 4.0V D.C.  
 (2) PCB mounted with 0.2"x0.2"(5.0mmx5.0mm) copper pad areas.

## Characteristics Curves

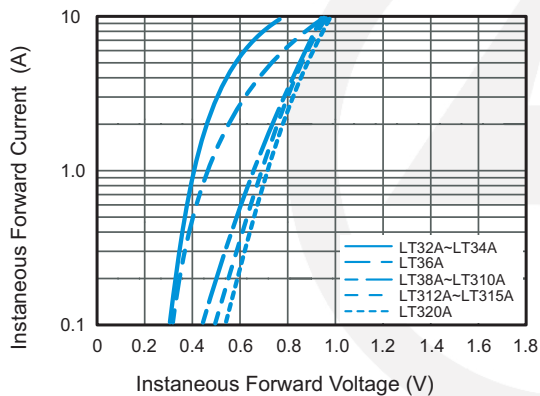
**Fig.1 Forward Current Derating Curve**



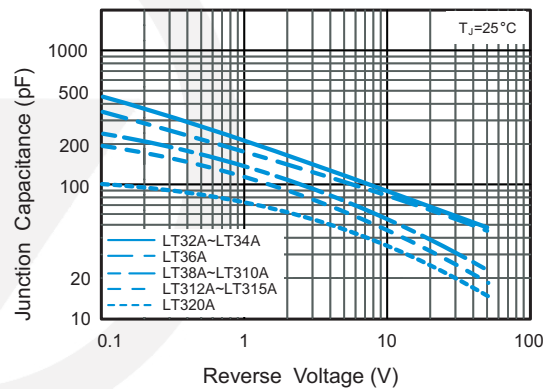
**Fig.2 Typical Reverse Characteristics**



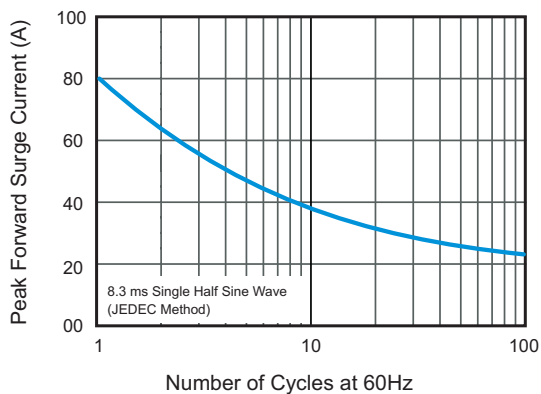
**Fig.3 Typical Forward Characteristic**



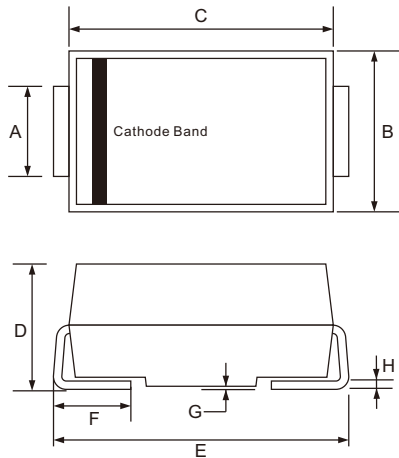
**Fig.4 Typical Junction Capacitance**



**Fig.5 Maximum Non-Repetitive Peak Forward Surge Current**



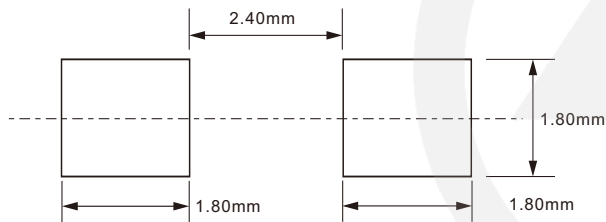
## SMA Package Outline



Unit: mm

SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	1.25	1.65
B	2.30	2.79
C	4.00	4.75
D	1.90	2.50
E	4.70	5.28
F	0.76	1.52
G	0.203 TYP.	
H	0.15	0.31

## SMA Suggested Pad Layout



**Note:**

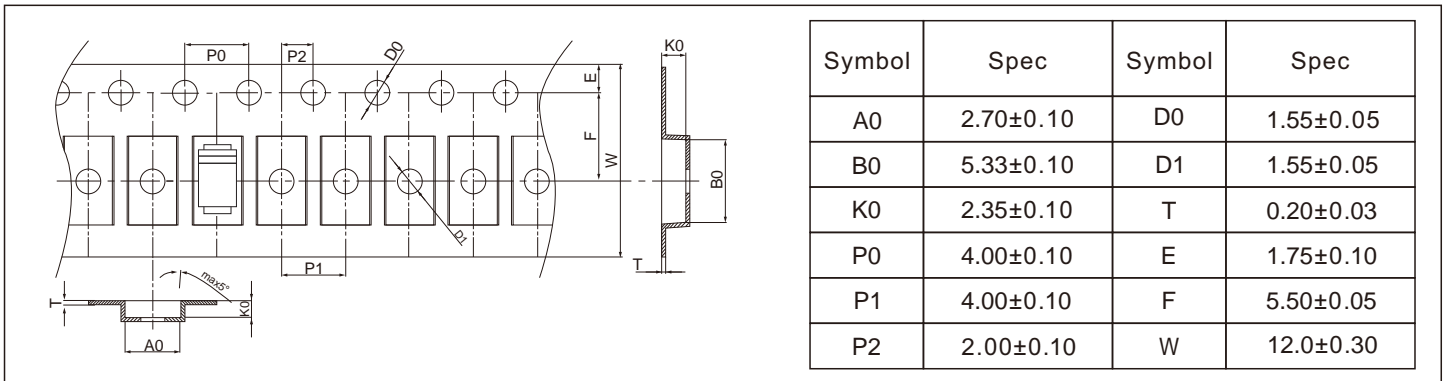
1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05\text{mm}$
3. The pad layout is for reference purpose only.

## Marking

Type number	Marking code
LT32A	SS32
LT34A	SS34
LT36A	SS36
LT38A	SS38
LT310A	SS310
LT312A	SS312
LT315A	SS315 or S315
LT320A	SS320 or S320

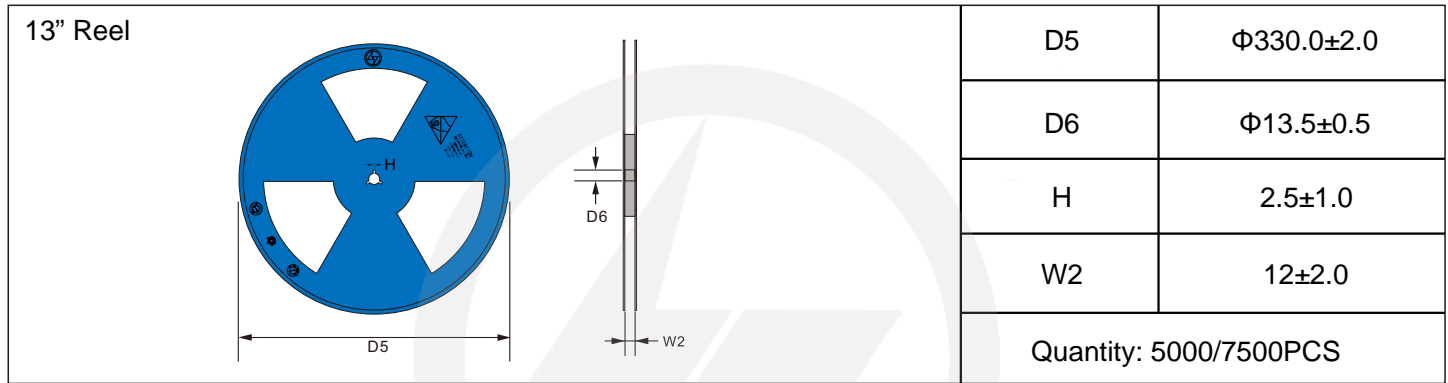
## Carrier Tape Dimensions

Unit : mm

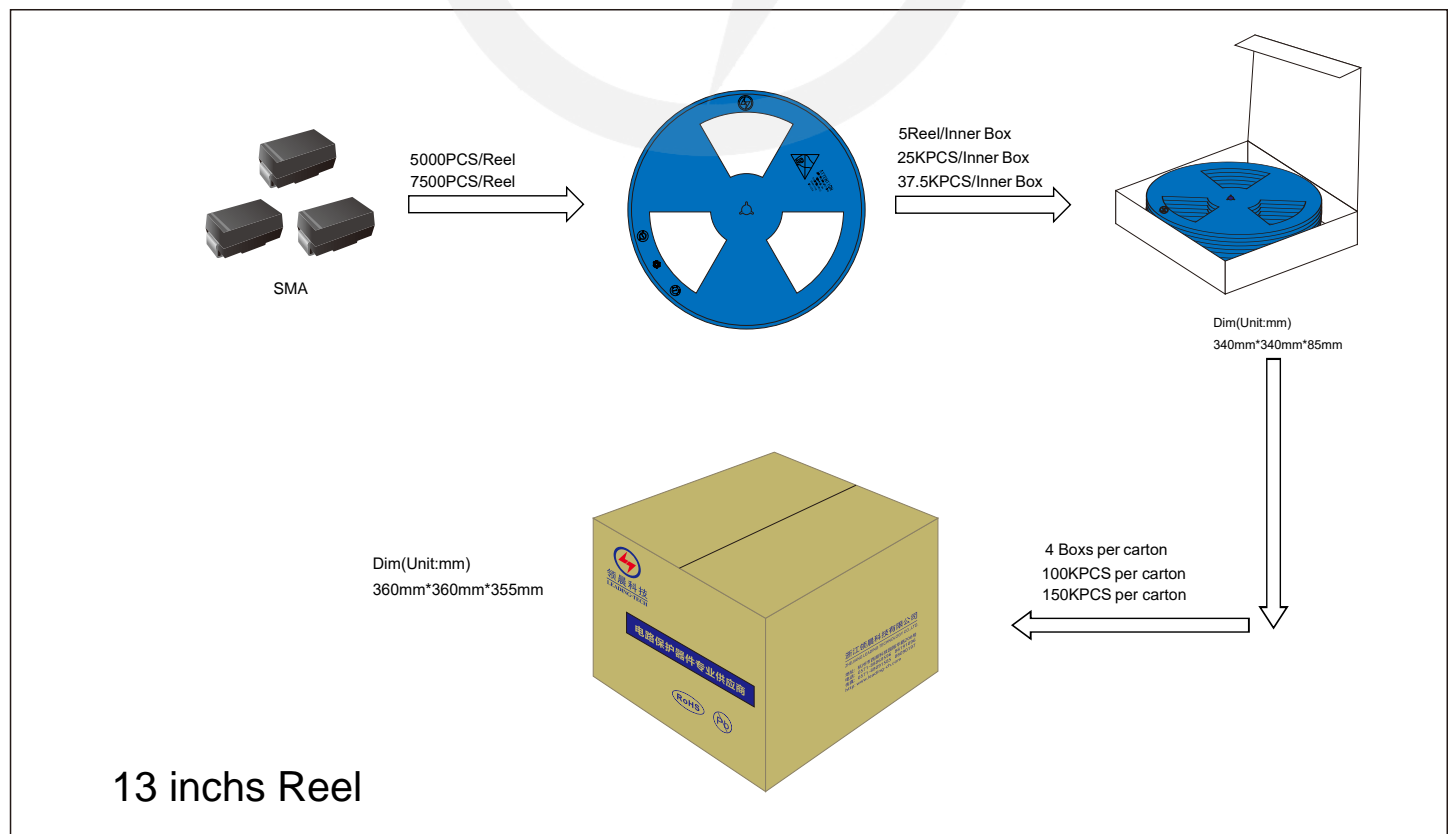


## Reel Dimensions

Unit : mm

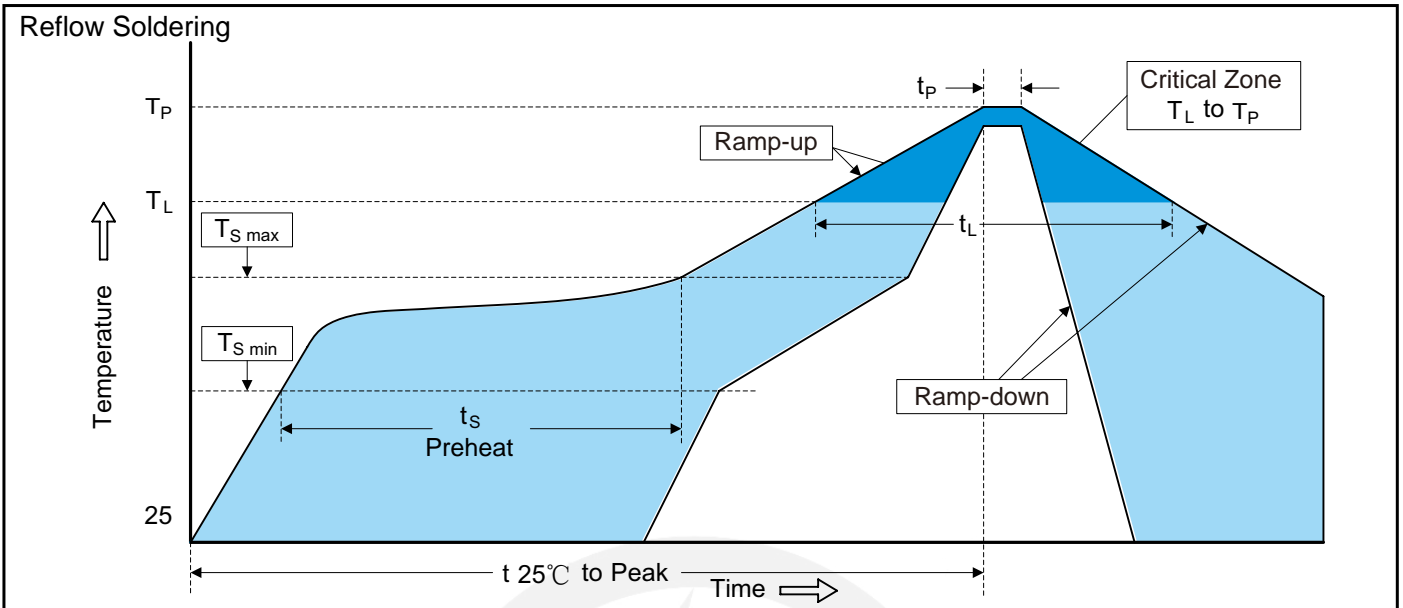


## Packaging





Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T <sub>L</sub> to T <sub>P</sub> )	3°C/second max.
Preheat	
-Temperature Min (T <sub>S min</sub> )	150°C
-Temperature Max (T <sub>S max</sub> )	200°C
-Time (min to max) (t <sub>s</sub> )	60-180 seconds
T <sub>S max</sub> to T <sub>L</sub>	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T <sub>L</sub> )	217°C
-Time (t <sub>L</sub> )	60-150 seconds
Peak Temperature (T <sub>P</sub> )	260°C
Time within 5°C of actual Peak Temperature (t <sub>p</sub> )	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

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## Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision content	Revision Reason	Revision Person	Note
01	2024.5.19	2024.5.19	3.0	New File	/	Ding	
02	2025.06.16	2025.06.16	3.1	Update packaging information	/	Ding	
03	2025.10.27	2025.10.27	3.2	Add Weight	/	Ding	